**Components marked 'DNP' should not be populated.**

**Assembly Variant: TIDA-00189_E2**

<table>
<thead>
<tr>
<th>PCB Viewed From Top Side</th>
<th>Board #: TIDA-00189</th>
<th>Rev: E1</th>
<th>Sun Rev: Not In Version Control</th>
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<tbody>
<tr>
<td>Ignore - Top Overlay</td>
<td></td>
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**Plot Name = Top Assembly Drawing**

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*Texas Instruments*
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: TIDA-00189_E2
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